

HVL396C

Variable Capacitance Diode for VCO

REJ03G0024-0100Z (Previous: ADE-208-1504)

> Rev.1.00 Apr.17.2003

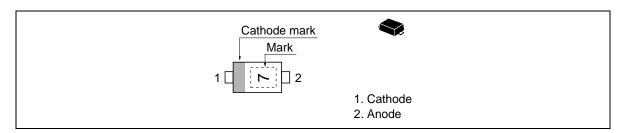
Features

- High capacitance ratio. (n = 2.30 min)
- Low series resistance. (rs = $0.4 \Omega \text{ max}$)
- Extremely small Flat Package (EFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code		
HVL396C	7	EFP		

Pin Arrangement



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Reverse voltage	V_R	10	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	–55 to +125	°C

Electrical Characteristics

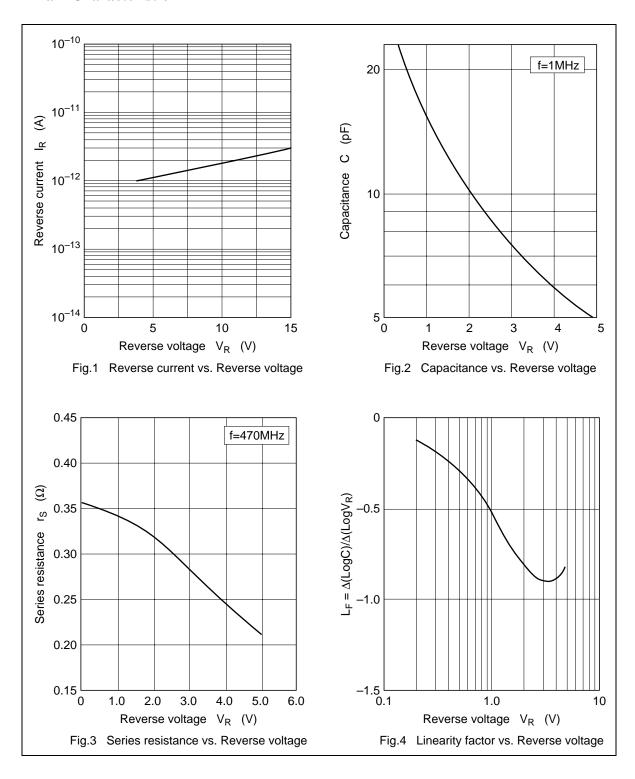
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I _{R1}	_	_	10	nA	V _R = 10 V
	I _{R2}	_	_	50		V _R = 10 V, Ta = 60°C
Capacitance	C ₁	14.5	_	17.5	pF	V _R = 1 V, f = 1 MHz
	C ₄	5.2	_	6.5		V _R = 4 V, f = 1 MHz
Capacitance ratio	n	2.3	_	_	_	C ₁ /C ₄
Series resistance	r _s	_	_	0.4	Ω	V _R = 1 V, f = 470 MHz

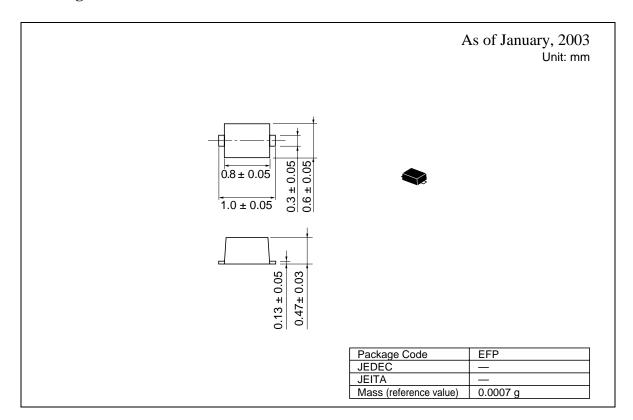
Notes: 1. Please do not use the soldering iron due to avoid high stress to the EFP package.

2. The material of lead is exposed for cutting plane. Therefore, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Main Characteristic



Package Dimensions



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